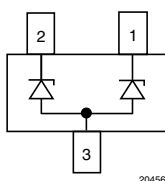


## Dual-Line ESD-Protection Diode Array in SOT-323



20456

22743

SOT-323

### MARKING (example only)



22744

ABC = type code (see table below)

WW = date code working week

VY = date code year

### FEATURES

- Compact SOT-323 package
- 2-line unidirectional ESD-protection
- AEC-Q101 qualified available
- Working range 1 V to 33 V
- ESD immunity acc. IEC 61000-4-2  
±15 kV to ±30 kV contact discharge  
±15 kV to ±30 kV air discharge
- Lead plating: Sn (e3)  
- soldering can be checked by standard vision inspection  
- AOI = Automated Optical Inspection
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

### LINKS TO ADDITIONAL RESOURCES



3D Models

ORDERING INFORMATION					
PART NUMBER (EXAMPLE)	AEC-Q101 QUALIFIED	ENVIRONMENTAL AND QUALITY CODE			ORDERING CODE (EXAMPLE)
		RoHS COMPLIANT + LEAD (Pb)-FREE TERMINATIONS	TIN PLATED	3K PER 7" REEL (8 mm TAPE)	
		GREEN		15K = MOQ	
VESD05A2-03G	-	G	3	-08	VESD05A2-03G-G3-08
VESD05A2-03G	H	G	3	-08	VESD05A2-03GHG3-08

PACKAGE DATA						
DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
VESD01A2-03G-G3	SOT-323	D01	5.2 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C
VESD03A2-03G-G3	SOT-323	D03				
VESD05A2-03G-G3	SOT-323	D05				
VESD08A2-03G-G3	SOT-323	D08				
VESD12A2-03G-G3	SOT-323	D12				
VESD16A2-03G-G3	SOT-323	D16				
VESD26A2-03G-G3	SOT-323	D26				
VESD33A2-03G-G3	SOT-323	D33				

**ABSOLUTE MAXIMUM RATINGS VESD01A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	11	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	70	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		30	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ABSOLUTE MAXIMUM RATINGS VESD03A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	11.6	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	100	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		30	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ABSOLUTE MAXIMUM RATINGS VESD05A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	8.7	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	100	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		30	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ABSOLUTE MAXIMUM RATINGS VESD08A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	6.60	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	100	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		30	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ABSOLUTE MAXIMUM RATINGS VESD12A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	4.4	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	100	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		30	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ABSOLUTE MAXIMUM RATINGS VESD16A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	3.6	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	100	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		30	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ABSOLUTE MAXIMUM RATINGS VESD26A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	2.1	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	100	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	20	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		20	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ABSOLUTE MAXIMUM RATINGS VESD33A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5, 8/20 µs/single shot	I <sub>PPM</sub>	1.6	A
Peak pulse power	Acc. IEC 61000-4-5, 8/20 µs/single shot	P <sub>PP</sub>	100	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	15	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		15	kV
Operating temperature	Junction temperature	T <sub>J</sub>	-55 to +150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

**ELECTRICAL CHARACTERISTICS VESD01A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	1	V
Reverse voltage	at I <sub>R</sub> = 100 µA	V <sub>R</sub>	1	1.2	-	V
Reverse current	at V <sub>R</sub> = 1 V	I <sub>R</sub>	-	20	100	µA
Reverse breakdown voltage	at I <sub>R</sub> = 20 mA	V <sub>BR</sub>	2.5	2.65	2.8	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 11 A, t <sub>p</sub> = 8/20 µs	V <sub>C</sub>	-	5.6	6.4	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 µs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 11 A, t <sub>p</sub> = 8/20 µs	V <sub>F</sub>	-	2.5	3.2	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	0.13	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	153	192	230	pF

**ELECTRICAL CHARACTERISTICS VESD03A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	3	V
Reverse voltage	at I <sub>R</sub> = 20 µA	V <sub>R</sub>	3	-	-	V
Reverse current	at V <sub>R</sub> = 3 V	I <sub>R</sub>	-	8	20	µA
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	4.4	4.65	4.9	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 11.6 A, t <sub>p</sub> = 8/20 µs	V <sub>C</sub>	-	7.8	8.70	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 µs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 11.6 A, t <sub>p</sub> = 8/20 µs	V <sub>F</sub>	-	2.6	3.32	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	0.19	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	89	112	135	pF

**ELECTRICAL CHARACTERISTICS VESD05A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	5	V
Reverse voltage	at I <sub>R</sub> = 1 µA	V <sub>R</sub>	5	-	-	V
Reverse current	at V <sub>R</sub> = 5 V	I <sub>R</sub>	-	0.01	0.1	µA
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	6.85	7.26	7.65	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 8.7 A, t <sub>p</sub> = 8/20 µs	V <sub>C</sub>	-	10.3	11.5	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 µs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 8.7 A, t <sub>p</sub> = 8/20 µs	V <sub>F</sub>	-	2.2	2.74	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	0.2	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	53	67	81	pF

**ELECTRICAL CHARACTERISTICS VESD08A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	8	V
Reverse voltage	at I <sub>R</sub> = 0.1 μA	V <sub>R</sub>	8	-	-	V
Reverse current	at V <sub>R</sub> = 8 V	I <sub>R</sub>	-	0.01	0.1	μA
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	9.5	10	10.5	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 6.6 A, t <sub>p</sub> = 8/20 μs	V <sub>C</sub>	-	13.7	15.3	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 μs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 6.6 A, t <sub>p</sub> = 8/20 μs	V <sub>F</sub>	-	1.9	2.32	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	0.23	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	37	47	57	pF

**ELECTRICAL CHARACTERISTICS VESD12A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	12	V
Reverse voltage	at I <sub>R</sub> = 0.1 μA	V <sub>R</sub>	12	-	-	V
Reverse current	at V <sub>R</sub> = 12 V	I <sub>R</sub>	-	0.01	0.1	μA
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	13.9	14.7	15.5	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 4.4 A, t <sub>p</sub> = 8/20 μs	V <sub>C</sub>	-	20.5	22.7	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 μs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 4.4 A, t <sub>p</sub> = 8/20 μs	V <sub>F</sub>	-	1.6	1.88	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	0.4	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	26	33	40	pF

**ELECTRICAL CHARACTERISTICS VESD16A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	16	V
Reverse voltage	at I <sub>R</sub> = 0.1 μA	V <sub>R</sub>	16	-	-	V
Reverse current	at V <sub>R</sub> = 16 V	I <sub>R</sub>	-	0.01	0.1	μA
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	17	17.9	18.8	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 3.6 A, t <sub>p</sub> = 8/20 μs	V <sub>C</sub>	-	25.3	28	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 μs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 3.6 A, t <sub>p</sub> = 8/20 μs	V <sub>F</sub>	-	1.5	1.72	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	0.53	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	21	27	33	pF

**ELECTRICAL CHARACTERISTICS VESD26A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	26	V
Reverse voltage	at I <sub>R</sub> = 0.1 μA	V <sub>R</sub>	26	-	-	V
Reverse current	at V <sub>R</sub> = 26 V	I <sub>R</sub>	-	< 0.01	0.1	μA
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	27.6	29.1	30.6	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 2.1 A, t <sub>p</sub> = 8/20 μs	V <sub>C</sub>	-	43	48	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 μs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 2.1 A, t <sub>p</sub> = 8/20 μs	V <sub>F</sub>	-	1.3	1.42	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	1.9	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	14	17.5	21	pF

**ELECTRICAL CHARACTERISTICS VESD33A2-03G**(T<sub>amb</sub> = 25 °C, between pin 1 - 3 or 2 - 3, unless otherwise specified)

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N <sub>channel</sub>	-	-	2	lines
Reverse stand off voltage	Max. reverse working voltage	V <sub>RWM</sub>	-	-	33	V
Reverse voltage	at I <sub>R</sub> = 0.1 μA	V <sub>R</sub>	33	-	-	V
Reverse current	at V <sub>R</sub> = 33 V	I <sub>R</sub>	-	< 0.01	0.1	μA
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	35.5	37.4	39.3	V
Reverse clamping voltage	at I <sub>PP</sub> = I <sub>PPM</sub> = 1.6 A, t <sub>p</sub> = 8/20 μs	V <sub>C</sub>	-	56	62.5	V
Forward clamping voltage	at I <sub>PP</sub> = 1 A, t <sub>p</sub> = 300 μs	V <sub>F</sub>	0.9	1.1	1.2	V
	at I <sub>PP</sub> = I <sub>PPM</sub> = 1.6 A, t <sub>p</sub> = 8/20 μs	V <sub>F</sub>	-	1.22	1.32	V
Dynamic resistance	t <sub>p</sub> = 100 ns (TLP; reverse direction)	r <sub>dyn</sub>	-	3.6	-	Ω
Capacitance	at V <sub>R</sub> = 0 V; f = 1 MHz	C <sub>D</sub>	12	15	18	pF

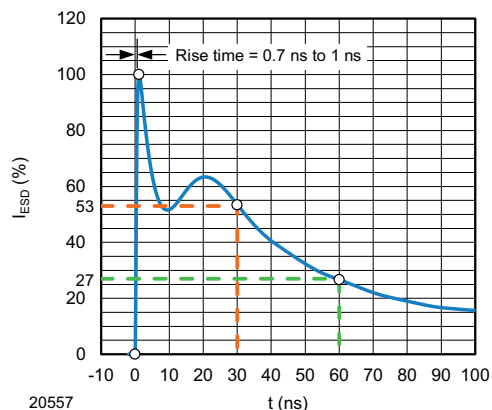


Fig. 1 - ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330  $\Omega$  / 150 pF)

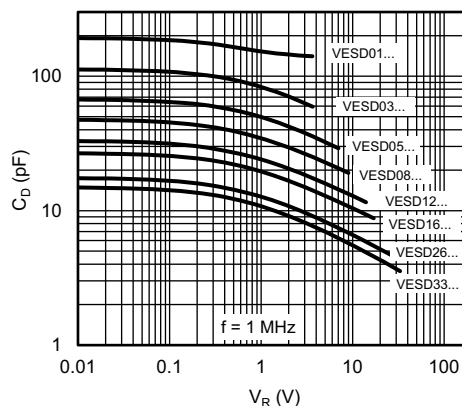


Fig. 4 - Typical Capacitance vs. Reverse Voltage

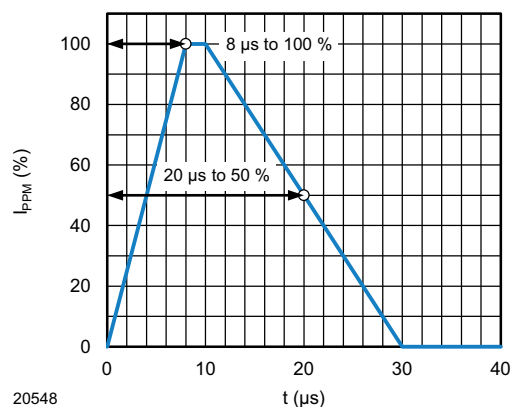


Fig. 2 - 8/20  $\mu$ s Peak Pulse Current Wave Form acc. IEC 61000-4-5

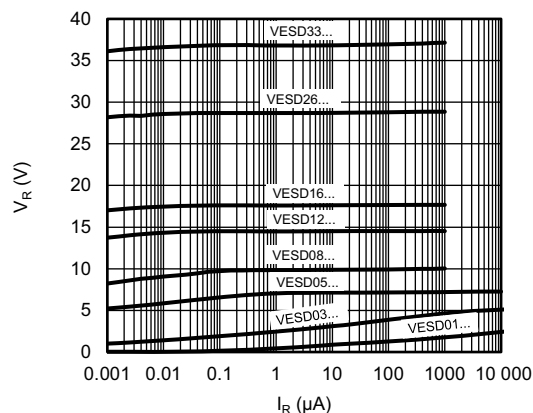


Fig. 5 - Typical Reverse Voltage vs. Reverse Current

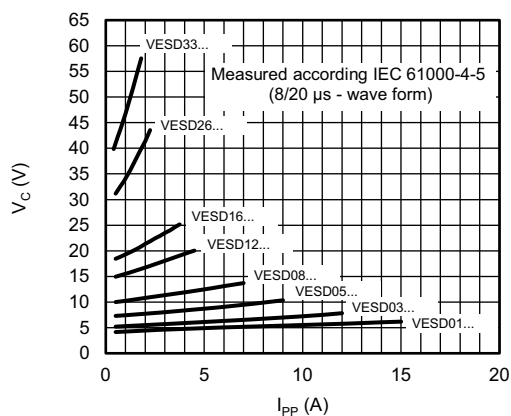


Fig. 3 - Typical Peak Clamping Voltage vs. Peak Pulse Current

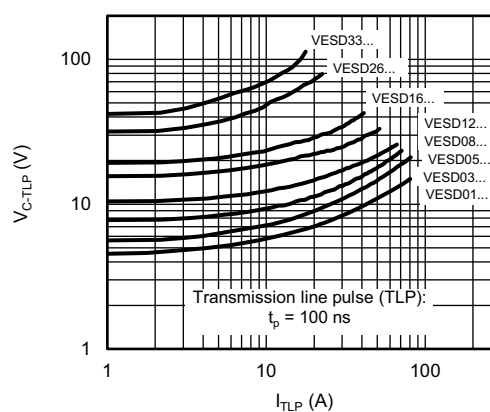


Fig. 6 - Typical Clamping Voltage vs. Peak Pulse Current

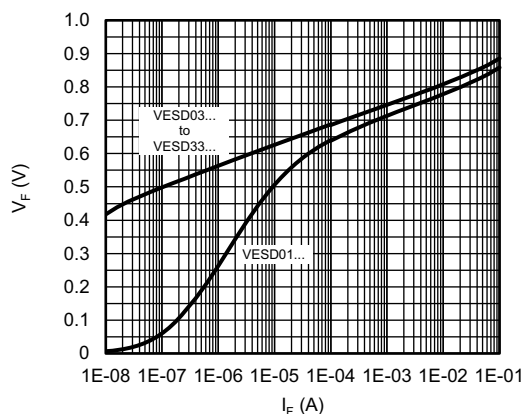


Fig. 7 - Typical Forward Voltage vs. Forward Current

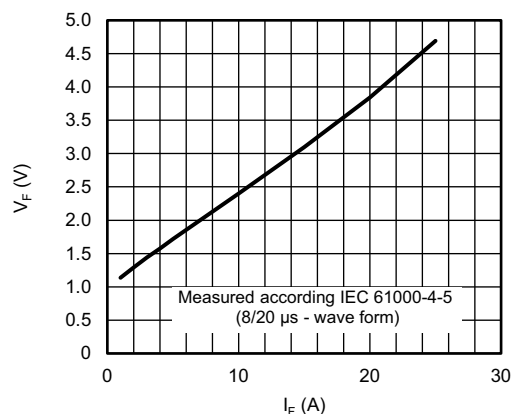
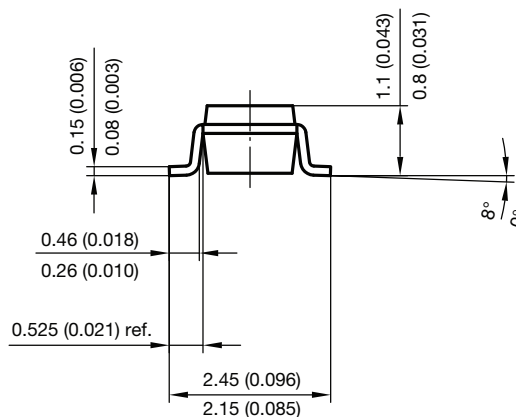
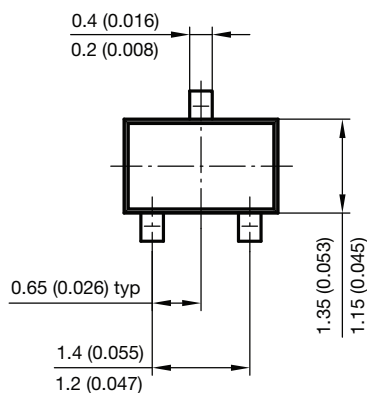
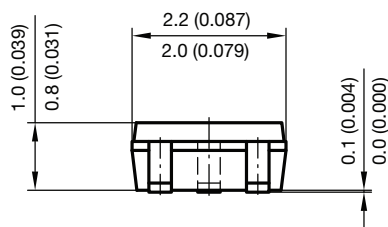
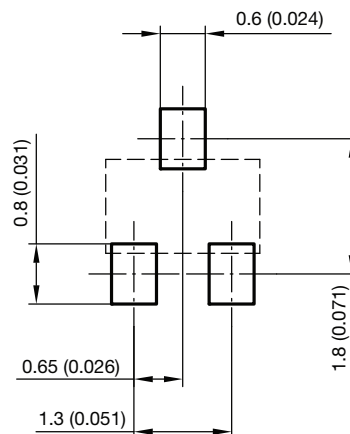


Fig. 8 - Typical Forward Voltage vs. Forward Current

## PACKAGE DIMENSIONS in millimeters (inches): SOT-323



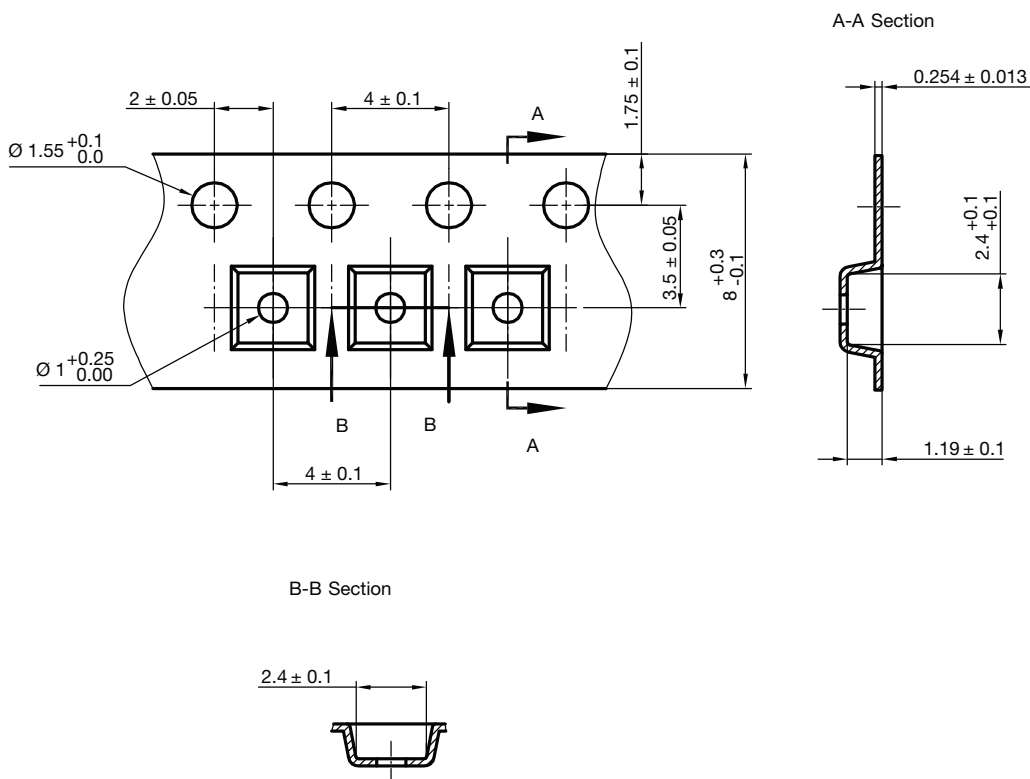
foot print recommendation:





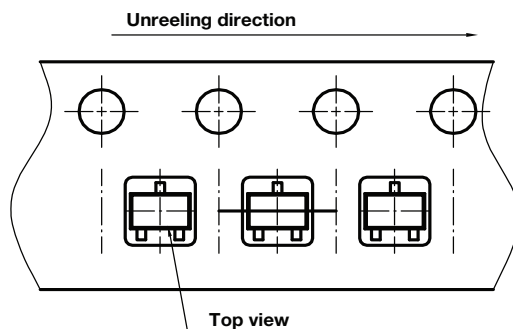


**CARRIER TAPE SOT-323**



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22762

**ORIENTATION IN CARRIER TAPE SOT-323**



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